# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





# LTC4278

### IEEE 802.3at PD with Synchronous No-Opto Flyback Controller and 12V Aux Support DESCRIPTION

### **FEATURES**

- 25.5W IEEE 802.3at Compliant (Type 2) PD
- 10V to 57V Auxiliary Power Input
- Shutdown Pin for Flexible Auxiliary Power Support
- Integrated State-of-the-Art No-Opto Synchronous Flyback Controller
  - Isolated Power Supply Efficiency >92%
  - 88% Efficiency Including Diode Bridge and Hot Swap<sup>™</sup> FET
- Superior EMI Performance
- Robust 100V 0.7 $\Omega$  (Typ) Integrated Hot Swap MOSFET
- IEEE 802.3at High Power Available Indicator
- Integrated Signature Resistor and Programmable Class Current
- Undervoltage, Overvoltage and Thermal Protection
- Short-Circuit Protection with Auto-Restart
- Programmable Soft-Start and Switching Frequency
- **Complementary Power Good Indicators**
- Thermally Enhanced 7mm × 4mm DFN Package

### **APPLICATIONS**

- VoIP Phones with Advanced Display Options
- **Dual-Radio Wireless Access Points**
- PTZ Security Cameras
- **RFID Readers**
- Industrial Controls

The LTC<sup>®</sup>4278 is an integrated Powered Device (PD) controller and switching regulator intended for high power IEEE 802.3at and 802.3af applications. With a wide input voltage range, the LTC4278 is specifically designed to support PD applications that include a low-voltage auxiliary power input such as a 12V wall adaptor. The inclusion of a shutdown pin provides simple implementation of both PoE and auxiliary dominate applications. In addition, the LTC4278 supports both 1-event and 2-event classifications as defined by the IEEE, thereby allowing the use in a wide range of product configurations.

The LTC4278 synchronous, current mode, flyback controller generates multiple supply rails in a single conversion step providing for the highest system efficiency while maintaining tight regulation across all outputs. The LTC4278 includes Linear Technology's patented No-Opto feedback topology to provide full IEEE 802.3 isolation without the need of an opto-isolator circuit. A true soft-start function allows graceful ramp-up of all output voltages.

The LTC4278 is available in a space saving 32-lead DFN package.

𝕶, LT, LTC, LTM, Linear Technology, SwitcherCAD and the Linear logo are registered trademarks and Hot Swap and ThinSOT are trademarks of Linear Technology Corporation. All other trademarks are the property of their respective owners. Protected by U.S. Patents, including 5841643.





### ABSOLUTE MAXIMUM RATINGS

(Notes 1, 2)

Pins with Respect to V <sub>PORTN</sub>	
VPOBTP Voltage	–0.3V to 100V
V <sub>NFG</sub> Voltage	-0.3V to VPORTP
V <sub>NFG</sub> Pull-Up Current	1A
SHDN	–0.3V to 100V
R <sub>CLASS</sub> , Voltage	0.3V to 7V
R <sub>CLASS</sub> Source Current	50mA
PWRGD Voltage (Note 3)	
Low Impedance Source V <sub>NEG</sub> –0.	.3V to V <sub>NEG</sub> +11V
Sink Current	5mA
PWRGD, T2P Voltage	0.3V to 100V
PWRGD, T2P Sink Current	10mA
Pins with Respect to GND	
V <sub>CC</sub> Voltage	–0.3V to 22V
SENSE <sup>-</sup> , SENSE <sup>+</sup> Voltage	0.5V to +0.5V
UVLO, SYNC Voltage	0.3V to V <sub>CC</sub>
FB Current	±2mA
V <sub>CMP</sub> Current	±1mA
Operating Ambient Temperature Range	
LTC4278C	0°C to 70°C
LTC42781	40°C to 85°C

### PIN CONFIGURATION



# ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LTC4278CDKD#PBF	LTC4278CDKD#TRPBF	4278	32-Lead (7mm $\times$ 4mm) Plastic DFN	0°C to 70°C
LTC4278IDKD#PBF	LTC4278IDKD#TRPBF	4278	32-Lead (7mm $\times$ 4mm) Plastic DFN	-40°C to 85°C

Consult LTC Marketing for parts specified with wider operating temperature ranges. \*The temperature grade is identified by a label on the shipping container. Consult LTC Marketing for information on non-standard lead based finish parts.

For more information on lead free part marking, go to: http://www.linear.com/leadfree/ For more information on tape and reel specifications, go to: http://www.linear.com/tapeandreel/



# **ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C.

PARAMETER	CONDITIONS			ТҮР	MAX	UNITS
Interface Controller (Note 4)	1		I			
Operating Input Voltage Signature Range Classification Range ON Voltage OFF Voltage Overvoltage Lockout	At V <sub>PORTP</sub> (Note 5)	•	1.5 12.5 30.0	71	60 9.8 21 37.2	V V V V V V
ON/OFF Hysteresis Window		•	4.1			V
Signature/Class Hysteresis Window		•	1.4			V
Reset Threshold	State Machine Reset for 2-Event Classification	•	2.57		5.40	V
Supply Current						
Supply Current at 57V	Measured at V <sub>PORTP</sub> Pin	•			1.35	mA
Class 0 Current	V <sub>PORTP</sub> = 17.5V, No R <sub>CLASS</sub> Resistor	•			0.40	mA
Signature	·					
Signature Resistance	$1.5V \le V_{PORTP} \le 9.8V$ (Note 6)	•	23.25		26	kΩ
Invalid Signature Resistance, SHDN Invoked	$1.5V \le V_{PORTP} \le 9.8V$ , $V_{SHDN} = 3V$ (Note 6)	٠			11	kΩ
Invalid Signature Resistance During Mark Event	(Notes 6, 7)	•			11	kΩ
Classification	·					
Class Accuracy	10mA < I <sub>CLASS</sub> < 40mA, 12.5V < V <sub>PORTP</sub> < 21V (Notes 8, 9)	•			±3.5	%
Classification Stability Time	V <sub>PORTP</sub> Pin Step to 17.5V, R <sub>CLASS</sub> = 30.9, I <sub>CLASS</sub> Within 3.5% of Ideal Value (Notes 8, 9)	•			1	ms
Normal Operation	·					
Inrush Current	V <sub>PORTP</sub> = 54V, V <sub>NEG</sub> = 3V		60	100	180	mA
Power FET On-Resistance	Tested at 600mA into $V_{NEG}$ , $V_{PORTP} = 54V$	•		0.7	1.0	Ω
Power FET Leakage Current at V <sub>NEG</sub>	$V_{PORTP} = SHDN = V_{NEG} = 57V$				1	μA
Digital Interface						
SHDN Input High Level Voltage		•	3			V
SHDN Input Low Level Voltage		•			0.45	V
SHDN Input Resistance	V <sub>PORTP</sub> = 9.8V, SHDN = 9.65V	•	100			kΩ
PWRGD, T2P Output Low Voltage	Tested at 1mA, $V_{PORTP} = 54V$ . For T2P, Must Complete 2-Event Classification to See Active Low	•			0.15	V
PWRGD, T2P Leakage Current	Pin Voltage Pulled 57V, $V_{PORTP} = V_{PORTN} = 0V$	•			1	μA
PWRGD Output Low Voltage	Tested at 0.5mA, $V_{PORTP}$ = 52V, $V_{NEG}$ = 48V, Output Voltage Is With Respect to $V_{NEG}$	•			0.4	V
PWRGD Clamp Voltage	Tested at 2mA, $V_{NEG}$ = 0V, Voltage With Respect to $V_{NEG}$	٠	12		16.5	V
PWRGD Leakage Current	$V_{PWRGD} = 11V$ , $V_{NEG} = 0V$ , Voltage With Respect to $V_{NEG}$	•			1	μA



# **ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C.

PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
PWM Controller (Note 10)	1			-		
Power Supply						
V <sub>CC</sub> Operating Range		•	4.5		20	V
V <sub>CC</sub> Supply Current (I <sub>CC</sub> )	V <sub>CMP</sub> = Open (Note 11)	•	4	6.4	10	mA
V <sub>CC</sub> Shutdown Current	V <sub>CMP</sub> = Open, V <sub>UVLO</sub> = 0V	•		50	150	μA
Feedback Amplifier		I				
Feedback Regulation Voltage (V <sub>FB</sub> )		•	1.220	1.237	1.251	V
Feedback Pin Input Bias Current	R <sub>CMP</sub> Open			200		nA
Feedback Amplifier Transconductance	$\Delta I_{C} = \pm 10 \mu A$	•	700	1000	1400	µmho
Feedback Amplifier Source or Sink Current		•	25	55	90	μA
Feedback Amplifier Clamp Voltage	$\begin{array}{l} V_{FB}=0.9V\\ V_{FB}=1.4V \end{array}$			2.56 0.84		V V
Reference Voltage Line Regulation	$12V \le V_{CC} \le 18V$	•		0.005	0.05	%/V
Feedback Amplifier Voltage Gain	V <sub>CMP</sub> = 1.2V to 1.7V			1400		V/V
Soft-Start Charging Current	V <sub>SFST</sub> = 1.5V		16	20	25	μA
Soft-Start Discharge Current	V <sub>SFST</sub> = 1.5V, V <sub>UVLO</sub> = 0V		0.7	1.3		mA
Control Pin Threshold (V <sub>CMP</sub> )	Duty Cycle = Min			1		V
Gate Outputs						
PG, SG Output High Level		•	6.6	7.4	8	V
PG, SG Output Low Level		•		0.01	0.05	V
PG, SG Output Shutdown Strength	V <sub>UVL0</sub> = 0V; I <sub>PG</sub> , I <sub>SG</sub> = 20mA	•		1.6	2.3	V
PG Rise Time	C <sub>PG</sub> = 1nF			11		ns
SG Rise Time	C <sub>SG</sub> = 1nF			15		ns
PG, SG Fall Time	C <sub>PG</sub> , C <sub>SG</sub> = 1nF			10		ns
Current Amplifier		I				
Switch Current Limit at Maximum V <sub>CMP</sub>	V <sub>SENSE</sub> <sup>+</sup>	•	88	98	110	mV
$\Delta V_{SENSE} / \Delta V_{CMP}$				0.07		V/V
Sense Voltage Overcurrent Fault Voltage	V <sub>SENSE</sub> <sup>+</sup> , V <sub>SFST</sub> < 1V	•		206	230	mV
Timing						
Switching Frequency (f <sub>OSC</sub> )	C <sub>OSC</sub> = 100pF	•	84	100	110	kHz
Oscillator Capacitor Value (C <sub>OSC</sub> )	(Note 12)		33		200	pF
Minimum Switch On Time (t <sub>ON(MIN)</sub> )				200		ns
Flyback Enable Delay Time (t <sub>ENDLY</sub> )				265		ns
PG Turn-On Delay Time (t <sub>PGDLY</sub> )				200		ns
Maximum Switch Duty Cycle			85	88		%
SYNC Pin Threshold		•		1.53	2.1	V
SYNC Pin Input Resistance				40		kΩ



# **ELECTRICAL CHARACTERISTICS** The $\bullet$ denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = 25^{\circ}C$ .

PARAMETER	CONDITIONS			ТҮР	MAX	UNITS
Load Compensation						
Load Compensation to V <sub>SENSE</sub> Offset Voltage	$V_{\text{RCMP}}$ with $V_{\text{SENSE}}^+ = 0V$			0.8		mV
Feedback Pin Load Compensation Current	$V_{SENSE}^{+}$ = 20mV, $V_{FB}$ = 1.230V		20			μA
UVLO Function		<sup>1</sup>				
UVLO Pin Threshold (V <sub>UVLO</sub> )		•	1.215	1.240	1.265	V
UVLO Pin Bias Current	$V_{UVL0} = 1.2V$ $V_{UVL0} = 1.3V$		-0.25 -4.50	0.1 -3.4	0.25 2.50	μA μA

**Note 1:** Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

Note 2: Pins with 100V absolute maximum guaranteed for  $T \ge 0^{\circ}C$ , otherwise 90V.

Note 3: Active high PWRGD internal clamp self-regulates to 14V with respect to  $V_{\text{NEG}}.$ 

Note 4: All voltages are with respect to  $V_{PORTN}$  pin unless otherwise noted.

**Note 5:** Input voltage specifications are defined with respect to LTC4278 pins and meet IEEE 802.3af/at specifications when the input diode bridge is included.

**Note 6:** Signature resistance is measured via the  $\Delta V/\Delta I$  method with the minimum  $\Delta V$  of 1V. The LTC4278 signature resistance accounts for the additional series resistance in the input diode bridge.

**Note 7:** An invalid signature after the 1st classification event is mandated by the IEEE802.3at standard. See the Applications Information section. **Note 8:** Class accuracy is with respect to the ideal current defined as

1.237/R\_{CLASS} and does not include variations in  $\mathsf{R}_{\text{CLASS}}$  resistance.

Note 9: This parameter is assured by design and wafer level testing.

**Note 10:**  $V_{CC} = 14V$ ; PG, SG Open;  $V_{CMP} = 1.4V$ ,  $V_{SENSE}^- = 0V$ ,  $R_{CMP} = 1k$ ,  $R_{tON} = 90k$ ,  $R_{PGDLY} = 27.4k$ ,  $R_{ENDLY} = 90k$ , unless otherwise specified. All voltages are with respect to GND.

**Note 11:** Supply current does not include gate charge current to the MOSFETs. See the Applications Information section.

Note 12: Component value range guaranteed by design.

















### PIN FUNCTIONS

**SHDN (Pin 1):** Shutdown Input. Use this pin for auxiliary power application. Drive SHDN high to disable LTC4278 operation and corrupt the signature resistance. If unused, tie SHDN to  $V_{PORTN}$ .

**T2P** (Pin 2): Type 2 PSE Indicator, Open-Drain. Low impedance indicates the presence of a Type 2 PSE.

 $R_{CLASS}$  (Pin 3): Class Select Input. Connect a resistor between  $R_{CLASS}$  and  $V_{PORTN}$  to set the classification load current (see Table 2).

NC (Pins 4, 7, 8, 25, 28, 31): No Connect.

**V<sub>PORTN</sub> (Pins 5, 6):** Input Voltage, Negative Rail. Pin 5 and Pin 6 must be electrically tied together at the package.

**SG (Pin 9):** Synchronous Gate Drive Output. This pin provides an output signal for a secondary-side synchronous rectifier. Large dynamic currents may flow during voltage transitions. See the Applications Information section for details.

**V<sub>CC</sub> (Pin 10):** Supply Voltage Pin. Bypass this pin to GND with a low ESR ceramic capacitor. See the Applications Information section for details.

 $t_{ON}$  (Pin 11): Pin for external programming resistor to set the minimum time that the primary switch is on for each cycle. Minimum turn-on facilitates the isolated feedback method. See the Applications Information section for details.

**ENDLY (Pin 12):** Pin for external programming resistor to set enable delay time. The enable delay time disables the feedback amplifier for a fixed time after the turn-off of the primary-side MOSFET. This allows the leakage inductance voltage spike to be ignored for flyback voltage sensing. See the Applications Information section for details.

**SYNC (Pin 13):** External Sync Input. This pin is used to synchronize the internal oscillator with an external clock. The positive edge of the clock causes the oscillator to discharge causing PG to go low (off) and SG high (on). The sync threshold is typically 1.5V. Tie to ground if unused. See the Applications Information section for details.

**SFST (Pin 14):** Soft-Start. This pin, in conjunction with a capacitor ( $C_{SFST}$ ) to GND, controls the ramp-up of peak primary current through the sense resistor. It is also used to control converter inrush at start-up. The SFST clamps the V<sub>CMP</sub> voltage and thus limits peak current until softstart is complete. The ramp time is approximately 70ms per  $\mu$ F of capacitance. Leave SFST open if not using the soft-start function.

**OSC (Pin 15):** Oscillator. This pin, in conjunction with an external capacitor ( $C_{OSC}$ ) to GND, defines the controller oscillator frequency. The frequency is approximately 100kHz • 100/ $C_{OSC}$  (pF).

**FB (Pin 16):** Feedback Amplifier Input. Feedback is usually sensed via a third winding and enabled during the flyback period. This pin also sinks additional current to compensate for load current variation as set by the R<sub>CMP</sub> pin. Keep the Thevenin equivalent resistance of the feedback divider at roughly 3k.

 $V_{CMP}$  (Pin 17): Frequency Compensation Control.  $V_{CMP}$  is used for frequency compensation of the switcher control loop. It is the output of the feedback amplifier and the input to the current comparator. Switcher frequency compensation components are placed on this pin to GND. The voltage on this pin is proportional to the peak primary switch current. The feedback amplifier output is enabled during the synchronous switch on time.

**UVLO (Pin 18):** Undervoltage Lockout. A resistive divider from V<sub>PORTP</sub> to this pin sets an undervoltage lockout based upon V<sub>PORTP</sub> level (not V<sub>CC</sub>). When the UVLO pin is below its threshold, the gate drives are disabled, but the part draws its normal quiescent current from V<sub>CC</sub>.

The bias current on this pin has hysteresis such that the bias current is sourced when UVLO threshold is exceeded. This introduces a hysteresis at the pin equivalent to the bias current change times the impedance of the upper divider resistor. The user can control the amount of hysteresis by adjusting the impedance of the divider. Tie the UVLO pin to  $V_{CC}$  if not using this function. See the Applications



### PIN FUNCTIONS

Information section for details. This pin is used for the UVLO function of the switching regulator. The PD interface section has an internal UVLO.

**SENSE<sup>-</sup>, SENSE<sup>+</sup> (Pins 19, 20):** Current Sense Inputs. These pins are used to measure primary-side switch current through an external sense resistor. Peak primary-side current is used in the converter control loop. Make Kelvin connections to the sense resistor  $R_{SENSE}$  to reduce noise problems. SENSE<sup>-</sup> connects to the GND side. At maximum current (V<sub>CMP</sub> at its maximum voltage) SENSE pins have 100mV threshold. The signal is blanked (ignored) during the minimum turn-on time.

 $C_{CMP}$  (Pin 21): Load Compensation Capacitive Control. Connect a capacitor from  $C_{CMP}$  to GND in order to reduce the effects of parasitic resistances in the feedback sensing path. A 0.1µF ceramic capacitor suffices for most applications. Short this pin to GND when load compensation is not needed.

 $R_{CMP}$  (Pin 22): Load Compensation Resistive Control. Connect a resistor from  $R_{CMP}$  to GND in order to compensate for parasitic resistances in the feedback sensing path. In less demanding applications, this resistor is not needed and this pin can be left open. See the Applications Information section for details. **PGDLY (Pin 23):** Primary Gate Delay Control. Connect an external programming resistor (R<sub>PGDLY</sub>) to set delay from synchronous gate turn-off to primary gate turn-on. See the Applications Information section for details.

**PG (Pin 24):** Primary Gate Drive. PG is the gate drive pin for the primary-side MOSFET switch. Large dynamic currents flow during voltage transitions. See the Applications Information section for details.

 $V_{NEG}$  (Pins 26, 27): System Negative Rail. Connects  $V_{NEG}$  to  $V_{PORTN}$  through an internal power MOSFET. Pin 26 and Pin 27 must be electrically tied together at the package.

**PWRGD (Pin 29):** Power Good Output, Open-Collector. High impedance signals power-up completion. PWRGD is referenced to  $V_{NEG}$  and features a 14V clamp.

**PWRGD** (Pin 30): Complementary Power Good Output, Open-Drain. Low impedance signals power-up completion. PWRGD is referenced to V<sub>PORTN</sub>.

**V**<sub>PORTP</sub> (**Pin 32**): Positive Power Input. Tie to the input port power through the input diode bridge.

**Exposed Pad (Pin 33):** Ground. This is the negative rail connection for both signal ground and gate driver grounds of the flyback controller. This pin should be connected to  $V_{\text{NEG}}$ .

## **BLOCK DIAGRAM**



12



#### **OVERVIEW**

Power over Ethernet (PoE) continues to gain popularity as more products are taking advantage of having DC power and high speed data available from a single RJ45 connector. As PoE continues to grow in the marketplace, powered device (PD) equipment vendors are running into the 12.95W power limit established by the IEEE 802.3af standard.

The IEE802.3at standard establishes a higher power allocation for Power over Ethernet while maintaining backwards compatibility with the existing IEEE 802.3af systems. Power sourcing equipment (PSE) and powered devices are distinguished as Type 1 complying with the IEEE 802.3af/ IEEE 802.3at power levels, or Type 2 complying with the IEEE 802.3at power levels. The maximum available power of a Type 2 PD is 25.5W.

The IEEE 802.3at standard also establishes a new method of acquiring power classification from a PD and communicating the presence of a Type 2 PSE. A Type 2 PSE has the option of acquiring PD power classification by performing 2-event classification (layer 1) or by communicating with the PD over the data line (layer 2). In turn, a Type 2 PD must be able to recognize both layers of communications and identify a Type 2 PSE.

The LTC4278 is specifically designed to support the front end of a PD that must operate under the IEEE 802.3at standard. In particular, the LTC4278 provides the T2P indicator bit which recognizes 2-event classification. This indicator bit may be used to alert the LTC4278 output load that a Type 2 PSE is present. With an internal signature resistor, classification circuitry, inrush control, and thermal shutdown, the LTC4278 is a complete PD Interface solution capable of supporting in the next generation PD applications.

#### **MODES OF OPERATION**

The LTC4278 has several modes of operation depending on the input voltage applied between the  $V_{PORTP}$  and  $V_{PORTN}$  pins. Figure 1 presents an illustration of voltage and current waveforms the LTC4278 may encounter with the various modes of operation summarized in Table 1.





# Table 1. LTC4278 Modes of Operation as a Function of Input Voltage

	ITC4278 MODES OF OPERATION
PURIP PURIN (*)	EIGHERO MODEO OF OF EITATION
0V to 1.4V	Inactive (Reset After 1st Classification Event)
1.5V to 9.8V (5.4V to 9.8V)	25k Signature Resistor Detection Before 1st Classification Event (Mark, 11k Signature Corrupt After 1st Classification Event)
12.5V to ON/OFF*	Classification Load Current Active
ON/OFF* to 60V	Inrush and Power Applied To PD Load
>71V	Overvoltage Lockout, Classification and Hot Swap Are Disabled

\*ON/OFF includes hysteresis. Rising input threshold, 37.2V Max. Falling input threshold, 30V Min.

These modes satisfy the requirements defined in the IEEE 802.3af/IEEE 802.3at specification.

#### **INPUT DIODE BRIDGE**

In the IEEE 802.3af/IEEE 802.3at standard, the modes of operation reference the input voltage at the PD's RJ45 connector. Since the PD must handle power received in either polarity from either the data or the spare pair, input diode bridges BR1 and BR2 are connected between the RJ45 connector and the LTC4278 (Figure 2).

The input diode bridge introduces a voltage drop that affects the range for each mode of operation. The LTC4278 compensates for these voltage drops so that a PD built with the LTC4278 meets the IEEE 802.3af/IEEE 802.3at-established voltage ranges. Note the Electrical Characteristics are referenced with respect to the LTC4278 package pins.

#### DETECTION

During detection, the PSE looks for a 25k signature resistor which identifies the device as a PD. The PSE will apply two voltages in the range of 2.8V to 10V and measures the corresponding currents. Figure 1 shows the detection voltages V1 and V2 and the corresponding PD current. The PSE calculates the signature resistance using the  $\Delta V/\Delta I$  measurement technique.

The LTC4278 presents its precision, temperature-compensated 25k resistor between the V<sub>PORTP</sub> and V<sub>PORTN</sub> pins, alerting the PSE that a PD is present and requests power to be applied. The LTC4278 signature resistor also compensates for the additional series resistance introduced by the input diode bridge. Thus a PD built with the LTC4278 conforms to the IEEE 802.3af/IEEE 802.3at specifications.



Figure 2. PD Front End Using Diode Bridges on Main and Spare Inputs



#### SIGNATURE CORRUPT OPTION

In some designs that include an auxiliary power option, it is necessary to prevent a PD from being detected by a PSE. The LTC4278 signature resistance can be corrupted with the SHDN pin (Figure 3). Taking the SHDN pin high will reduce the signature resistor below 11k which is an invalid signature per the IEEE 802.3af/IEEE 802.3at specification, and alerts the PSE not to apply power. Invoking the SHDN pin also ceases operation for classification and disconnects the LTC4278 load from the PD input. If this feature is not used, connect SHDN to V<sub>PORTN</sub>.



Figure 3. 25k Signature Resistor with Disable

#### CLASSIFICATION

Classification provides a method for more efficient power allocation by allowing the PSE to identify a PD power classification. Class 0 is included in the IEEE specification for PDs that do not support classification. Class 1-3 partitions PDs into three distinct power ranges. Class 4 includes the new power range under IEEE802.3at (see Table 2).

During classification probing, the PSE presents a fixed voltage between 15.5V and 20.5V to the PD (Figure 1). The LTC4278 asserts a load current representing the PD power classification. The classification load current is programmed with a resistor  $R_{CLASS}$  that is chosen from Table 2.

Table 2. Summary of Power Classifications and LTC4278  $R_{\mbox{CLASS}}$  Resistor Selection

CLASS	USAGE	MAXIMUM POWER LEVELS AT INPUT OF PD (W)	NOMINAL Classification Load current (mA)	LTC4278 R <sub>CLASS</sub> RESISTOR (Ω, 1%)
0	Type 1	0.44 to 12.95	< 0.4	Open
1	Type 1	0.44 to 3.84	10.5	124
2	Type 1	3.84 to 6.49	18.5	69.8
3	Type 1	6.49 to 12.95	28	45.3
4	Type 2	12.95 to 25.5	40	30.9

#### 2-EVENT CLASSIFICATION AND THE $\overline{\text{T2P}}$ PIN

A Type 2 PSE may declare the availability of high power by performing a 2-event classification (layer 1) or by communicating over the high speed data line (layer 2). A Type 2 PD must recognize both layers of communication. Since layer 2 communication takes place directly between the PSE and the LTC4278 load, the LTC4278 concerns itself only with recognizing 2-event classification.

In 2-event classification, a Type 2 PSE probes for power classification twice. Figure 4 presents an example of a 2-event classification. The 1st classification event occurs when the PSE presents an input voltage between 15.5V to 20.5V and the LTC4278 presents a class 4 load current. The PSE then drops the input voltage into the mark voltage range of 7V to 10V, signaling the 1st mark event. The PD in the mark voltage range presents a load current between 0.25mA to 4mA.

The PSE repeats this sequence, signaling the 2nd Classification and 2nd mark event occurrence. This alerts the LTC4278 that a Type 2 PSE is present. The Type 2 PSE then applies power to the PD and the LTC4278 charges up the reservoir capacitor C1 with a controlled inrush current. When C1 is fully charged, and the LTC4278 declares power good, the T2P pin presents an active low signal, or low impedance output with respect to V<sub>PORTN</sub>. The T2P output becomes inactive when the LTC4278 input voltage falls below undervoltage lockout threshold.





Figure 4.  $V_{\text{NEG}},$   $\overline{\text{T2P}}$  and PD Current as a Result of 2-Event Classification

#### SIGNATURE CORRUPT DURING MARK

As a member of the IEEE 802.3at working group, Linear Technology noted that it is possible for a Type 2 PD to receive a false indication of a 2-event classification if a PSE port is pre-charged to a voltage above the detection voltage range before the first detection cycle. The IEEE working group modified the standard to prevent this possibility by requiring a Type 2 PD to corrupt the signature resistance during the mark event, alerting the PSE not to apply power. The LTC4278 conforms to this standard by corrupting the signature resistance. This also discharges the port before the PSE begins the next detection cycle.

#### PD STABILITY DURING CLASSIFICATION

Classification presents a challenging stability problem due to the wide range of possible classification load current. The onset of the classification load current introduces a voltage drop across the cable and increases the forward voltage of the input diode bridge. This may cause the PD to oscillate between detection and classification with the onset and removal of the classification load current.

The LTC4278 prevents this oscillation by introducing a voltage hysteresis window between the detection and classification ranges. The hysteresis window accommodates the voltage changes a PD encounters at the onset of the classification load current, thus providing a trouble-free transition between detection and classification modes.

The LTC4278 also maintains a positive I-V slope throughout the classification range up to the on-voltage. In the event a PSE overshoots beyond the classification voltage range, the available load current aids in returning the PD back into the classification voltage range. (The PD input may otherwise be "trapped" by a reverse-biased diode bridge and the voltage held by the  $0.1\mu$ F capacitor).

#### **INRUSH CURRENT**

Once the PSE detects and optionally classifies the PD, the PSE then applies powers on the PD. When the LTC4278 input voltage rises above the on-voltage threshold, LTC4278 connects  $V_{NEG}$  to  $V_{PORTN}$  through the internal power MOSFET.



To control the power-on surge currents in the system, the LTC4278 provides a fixed inrush current, allowing C1 to ramp up to the line voltage in a controlled manner.

The LTC4278 keeps the PD inrush current below the PSE current limit to provide a well controlled power-up characteristic that is independent of the PSE behavior. This ensures a PD using the LTC4278 interoperability with any PSE.

#### TURN-ON/TURN-OFF THRESHOLD

The IEEE 802.3af/at specification for the PD dictates a maximum turn-on voltage of 42V and a minimum turn-off voltage of 30V. This specification provides an adequate voltage to begin PD operation, and to discontinue PD operation when the input voltage is too low. In addition, this specification allows PD designs to incorporate an ON/ OFF hysteresis window to prevent start-up oscillations.

The LTC4278 features an ON/OFF hysteresis window (see Figure 5) that conforms with the IEEE 802.3af/at specification and accommodates the voltage drop in the cable and input diode bridge at the onset of the inrush current.

Once C1 is fully charged, the LTC4278 turns on is internal MOSFET and passes power to the PD load. The LTC4278 continues to power the PD load as long as the input voltage does not fall below the OFF threshold. When the LTC4278 input voltage falls below the OFF threshold, the PD load



#### **COMPLEMENTARY POWER GOOD**

When LTC4278 fully charges the load capacitor (C1), power good is declared and the LTC4278 load can safely begin operation. The LTC4278 provides complementary power good signals that remain active during normal operation and are de-asserted when the input voltage falls below the OFF threshold, when the input voltage exceeds the overvoltage lockout (OVLO) threshold, or in the event of a thermal shutdown (see Figure 6).

The PWRGD pin features an open collector output referenced to  $V_{\text{NEG}}$  which can interface directly with the UVLO pin. When power good is declared and active, the PWRGD pin is high impedance with respect to  $V_{\text{NEG}}$ . An internal 14V clamp protects the UVLO pin from an excessive voltage.

The active low  $\overline{PWRGD}$  pin connects to an internal, opendrain MOSFET referenced to V<sub>PORTN</sub> and may be used as an indicator bit when power good is declared and active. The  $\overline{PWRGD}$  pin is low impedance with respect to V<sub>PORTN</sub>.



Figure 5. LTC4278 ON/OFF and Overvoltage Lockout



Figure 6. LTC4278 Power Good Functional and State Diagram

4278fc



#### PWRGD PIN WHEN SHDN IS INVOKED

In PD applications where an auxiliary power supply invokes the SHDN feature, the PWRGD pin becomes high impedance. This prevents the PWRGD pin that is connected to the UVLO pin from interfering with the DC/DC converter operations when powered by an auxiliary power supply.

#### **OVERVOLTAGE LOCKOUT**

The LTC4278 includes an overvoltage lockout (OVLO) feature (Figure 6) which protects the LTC4278 and its load from an overvoltage event. If the input voltage exceeds the OVLO threshold, the LTC4278 discontinues PD operation. Normal operations resume when the input voltage falls below the OVLO threshold and when C1 is charged up.

#### THERMAL PROTECTION

The IEEE 802.3af/at specification requires a PD to withstand any applied voltage from 0V to 57V indefinitely. However, there are several possible scenarios where a PD may encounter excessive heating.

During classification, excessive heating may occur if the PSE exceeds the 75ms probing time limit. At turn-on, when the load capacitor begins to charge, the instantaneous power dissipated by the PD interface can be large before it reaches the line voltage. And if the PD experiences a fast input positive voltage step in its operational mode (for example, from 37V to 57V), the instantaneous power dissipated by the PD Interface can be large.

The LTC4278 includes a thermal protection feature which protects the LTC4278 from excessive heating. If the LTC4278 junction temperature exceeds the over-temperature threshold, the LTC4278 discontinues PD operations and power good becomes inactive. Normal operation resumes when the junction temperature falls below the overtemperature threshold and when C1 is charged up.

#### EXTERNAL INTERFACE AND COMPONENT SELECTION

#### Transformer

Nodes on an Ethernet network commonly interface to the outside world via an isolation transformer. For PDs, the

isolation transformer must also include a center tap on the RJ45 connector side (see Figure 7).

The increased current levels in a Type 2 PD over a Type 1 increase the current imbalance in the magnetics which can interfere with data transmission. In addition, proper termination is also required around the transformer to provide correct impedance matching and to avoid radiated and conducted emissions. Transformer vendors such as Bel Fuse, Coilcraft, Halo, Pulse, and Tyco (Table 4) can assist in selecting an appropriate isolation transformer and proper termination methods.

Table 4.	Power	over	Ethernet	Transformer	Vendors
----------	-------	------	----------	-------------	---------

VENDOR	CONTACT INFORMATION
Bel Fuse Inc.	206 Van Vorst Street Jersey City, NJ 07302 Tel: 201-432-0463 www.belfuse.com
Coilcraft Inc.	1102 Silver Lake Road Gary, IL 60013 Tel: 847-639-6400 www.coilcraft.com
Halo Electronics	1861 Landings Drive Mountain View, CA 94043 Tel: 650-903-3800 www.haloelectronics.com
PCA Electronics	16799 Schoenborn Street North Hills, CA 91343 Tel: 818-892-0761 www.pca.com
Pulse Engineering	12220 World Trade Drive San Diego, CA 92128 Tel: 858-674-8100 www.pulseeng.com
Tyco Electronics	308 Constitution Drive Menlo Park, CA 94025-1164 Tel: 800-227-7040 www.circuitprotection.com

#### Input Diode Bridge

Figure 2 shows how two diode bridges are typically connected in a PD application. One bridge is dedicated to the data pair while the other bridge is dedicated to the spare pair. The LTC4278 supports the use of either silicon or Schottky input diode bridges. However, there are tradeoffs in the choice of diode bridges.



An input diode bridge must be rated above the maximum current the PD application will encounter at the temperature the PD will operate. Diode bridge vendors typically call out the operating current at room temperature, but derate the maximum current with increasing temperature. Consult the diode bridge vendors for the operating current derating curve.

A silicon diode bridge can consume over 4% of the available power in some PD applications. Using Schottky diodes can help reduce the power loss with a lower forward voltage.

A Schottky bridge may not be suitable for some high temperature PD application. The leakage current has a voltage dependency that can reduce the perceived signature resistance. In addition, the IEEE 802.3af/at specification mandates the leakage back-feeding through the unused bridge cannot generate more than 2.8V across a 100k resistor when a PD is powered with 57V.

#### **Sharing Input Diode Bridges**

At higher temperatures, a PD design may be forced to consider larger bridges in a bigger package because the maximum operating current for the input diode bridge is drastically derated. The larger package may not be acceptable in some space-limited environments. One solution to consider is to reconnect the diode bridges so that only one of the four diodes conducts current in each package. This configuration extends the maximum operating current while maintaining a smaller package profile. Figure 7 shows how to reconnect the two diode bridges. Consult the diode bridge vendors for the derating curve when only one of four diodes is in operation.

#### **Input Capacitor**

The IEEE 802.3af/at standard includes an impedance requirement in order to implement the AC disconnect function. A  $0.1\mu$ F capacitor (C14 in Figure 7) is used to meet this AC impedance requirement.

#### **Transient Voltage Suppressor**

The LTC4278 specifies an absolute maximum voltage of 100V and is designed to tolerate brief overvoltage events. However, the pins that interface to the outside world can routinely see excessive peak voltages. To protect the LTC4278, install a transient voltage suppressor (D3) between the input diode bridge and the LTC4278 as shown in Figure 7.



Figure 7. PD Front-End with Isolation Transformer, Diode Bridges, Capacitors, and a Transient Voltage Suppressor (TVS)



#### Classification Resistor (R<sub>CLASS</sub>)

The R<sub>CLASS</sub> resistor sets the classification load current, corresponding to the PD power classification. Select the value of R<sub>CLASS</sub> from Table 2 and connect the resistor between the R<sub>CLASS</sub> and V<sub>PORTN</sub> pins as shown in Figure 4, or float the R<sub>CLASS</sub> pin if the classification load current is not required. The resistor tolerance must be 1% or better to avoid degrading the overall accuracy of the classification circuit.

#### Load Capacitor

The IEEE 802.3af/at specification requires that the PD maintains a minimum load capacitance of  $5\mu$ F and does not specify a maximum load capacitor. However, if the load capacitor is too large, there may be a problem with inadvertent power shutdown by the PSE.

This occurs when the PSE voltage drops quickly. The input diode bridge reverses bias, and the PD load momentarily powers off the load capacitor. If the PD does not draw power within the PSE's 300ms disconnection delay, the PSE may remove power from the PD. Thus, it is necessary to evaluate the load current and capacitance to ensure that an inadvertent shutdown cannot occur.

The load capacitor can store significant energy when fully charged. The PD design must ensure that this energy is not inadvertently dissipated in the LTC4278. For example, if the  $V_{PORTP}$  pin shorts to  $V_{PORTN}$  while the capacitor is charged, current will flow through the parasitic body diode of the internal MOSFET and may cause permanent damage to the LTC4278.

#### T2P Interface

When a 2-event classification sequence successfully completes, the LTC4278 recognizes this sequence, and provides an indicator bit, declaring the presence of a Type 2 PSE. The open-drain output provides the option to use this signal to communicate to the LTC4278 load, or to leave the pin unconnected.

Figure 8 shows two interface options using the  $\overline{T2P}$  pin and the opto-isolator. The  $\overline{T2P}$  pin is active low and connects to an opto-isolator to communicate across the DC/



OPTION 1: SERIES CONFIGURATION FOR ACTIVE LOW/LOW IMPEDANCE OUTPUT



OPTION 2: SHUNT CONFIGURATION FOR ACTIVE HIGH/OPEN COLLECTOR OUTPUT

Figure 8. T2P Interface Examples

DC converter isolation barrier. The pull-up resistor R<sub>P</sub> is sized according to the requirements of the opto-isolator operating current, the pull-down capability of the T2P pin, and the choice of V<sup>+</sup>. V<sup>+</sup> for example can come from the PoE supply rail (which the LTC4278 V<sub>PORTP</sub> is tied to), or from the voltage source that supplies power to the DC/DC converter. Option 1 has the advantage of not drawing power unless T2P is declared active.

#### **Shutdown Interface**

To corrupt the signature resistance, the SHDN pin can be driven high with respect to  $V_{\text{PORTN}}.$  If unused, connect SHDN directly to  $V_{\text{PORTN}}.$ 

#### **Auxiliary Power Source**

In some applications, it is desirable to power the PD from an auxiliary power source such as a wall adapter.

Auxiliary power can be injected into an LTC4278-based PD at the input of the LTC4278  $V_{PORTN}$ , at  $V_{NEG}$ , or even the power supply output. In addition, some PD applications may desire auxiliary supply dominance or may be configured





for PoE dominance. Furthermore, PD applications may also opt for a seamless transition — that is, without power disruption — between PoE and auxiliary power.

The most common auxiliary power option injects power at  $V_{NEG}$ . Figure 9 presents an example of this application. In this example, the auxiliary port injects 48V onto the line via diode D1. The components surrounding the SHDN pin are selected so that the LTC4278 does not disconnect power to the output until the auxiliary supply exceeds 36V.

This configuration is an auxiliary-dominant configuration. That is, the auxiliary power source supplies the power even if PoE power is already present. This configuration also provides a seamless transition from PoE to auxiliary power when auxiliary power is applied, however, the removal of auxiliary power to PoE power is not seamless.

Contact Linear Technology applications support for detail information on implementing a custom auxiliary power supply.

#### IEEE 802.3at SYSTEM POWER-UP REQUIREMENT

Under the IEEE 802.3at standard, a PD must operate under 12.95W in accordance with IEEE 802.3at standard until it recognizes a Type 2 PSE. Initializing PD operation in 12.95W mode eliminates interoperability issue in case a Type 2 PD connects to a Type 1 PSE. Once the PD recognizes a

Type 2 PSE, the IEEE 802.3at standard requires the PD to wait 80ms in 12.95W operation before 25.5W operation can commence.

#### **MAINTAIN POWER SIGNATURE**

In an IEEE 802.3af/at system, the PSE uses the maintain power signature (MPS) to determine if a PD continues to require power. The MPS requires the PD to periodically draw at least 10mA and also have an AC impedance less than 26.25k in parallel with 0.05µF. If one of these conditions is not met, the PSE may disconnect power to the PD.

#### SWITCHING REGULATOR OVERVIEW

The LTC4278 includes a current mode converter designed specifically for use in an isolated flyback topology employing synchronous rectification. The LTC4278 operation is similar to traditional current mode switchers. The major difference is that output voltage feedback is derived via sensing the output voltage through the transformer. This precludes the need of an opto-isolator in isolated designs, thus greatly improving dynamic response and reliability. The LTC4278 has a unique feedback amplifier that samples a transformer winding voltage during the flyback period and uses that voltage to control output voltage. The internal blocks are similar to many current mode controllers. The differences lie in the feedback amplifier and load



Figure 9. Auxiliary Power Dominant PD Interface Example

compensation circuitry. The logic block also contains circuitry to control the special dynamic requirements of flyback control. For more information on the basics of current mode switcher/controllers and isolated flyback converters see Application Note 19.

#### Feedback Amplifier—Pseudo DC Theory

For the following discussion, refer to the simplified Switching Regulator Feedback Amplifier diagram (Figure 10A). When the primary-side MOSFET switch MP turns off, its drain voltage rises above the  $V_{PORTP}$  rail. Flyback occurs when the primary MOSFET is off and the synchronous secondary MOSFET is on. During flyback the voltage on nondriven transformer pins is determined by the secondary voltage. The amplitude of this flyback pulse, as seen on the third winding, is given as:

$$V_{FLBK} = \frac{V_{OUT} + I_{SEC} \bullet (ESR + R_{DS(ON)})}{N_{SE}}$$

R<sub>DS(ON)</sub> = on-resistance of the synchronous MOSFET MS

I<sub>SEC</sub> = transformer secondary current

ESR = impedance of secondary circuit capacitor, winding and traces

 $N_{SF}$  = transformer effective secondary-to-flyback winding turns ratio (i.e.,  $N_S/N_{FLBK}$ )

The flyback voltage is scaled by an external resistive divider R1/R2 and presented at the FB pin. The feedback amplifier compares the voltage to the internal bandgap reference. The feedback amp is actually a transconductance amplifier whose output is connected to  $V_{CMP}$  only during a period in the flyback time. An external capacitor on the  $V_{CMP}$  pin integrates the net feedback amp current to provide the control voltage to set the current mode trip point. The regulation voltage at the FB pin is nearly equal to the bandgap reference  $V_{FB}$  because of the high gain in the overall loop. The relationship between  $V_{FLBK}$  and  $V_{FB}$  is expressed as:

$$V_{FLBK} = \frac{R1 + R2}{R2} \bullet V_{FB}$$

Combining this with the previous  $V_{FLBK}$  expression yields an expression for  $V_{OUT}$  in terms of the internal reference, programming resistors and secondary resistances:

$$V_{OUT} = \left(\frac{R1 + R2}{R2} \bullet V_{FB} \bullet N_{SF}\right) - I_{SEC} \bullet \left(ESR + R_{DS(ON)}\right)$$

The effect of nonzero secondary output impedance is discussed in further detail (see Load Compensation Theory). The practical aspects of applying this equation for  $V_{OUT}$  are found in subsequent sections of the Applications Information.

#### Feedback Amplifier Dynamic Theory

So far, this has been a pseudo-DC treatment of flyback feedback amplifier operation. But the flyback signal is a pulse, not a DC level. Provision is made to turn on the flyback amplifier only when the flyback pulse is present, using the enable signal as shown in the timing diagram (Figure 10b).

#### Minimum Output Switch On Time (t<sub>ON(MIN)</sub>)

The LTC4278 affects output voltage regulation via flyback pulse action. If the output switch is not turned on, there is no flyback pulse and output voltage information is not available. This causes irregular loop response and start-up/latchup problems. The solution is to require the primary switch to be on for an absolute minimum time per each oscillator cycle. To accomplish this the current limit feedback is blanked each cycle for  $t_{ON(MIN)}$ . If the output load is less than that developed under these conditions, forced continuous operation normally occurs. See subsequent discussions in the Applications Information section for further details.

#### Enable Delay Time (ENDLY)

The flyback pulse appears when the primary-side switch shuts off. However, it takes a finite time until the transformer primary-side voltage waveform represents the output voltage. This is partly due to rise time on the primaryside MOSFET drain node, but, more importantly, is due







Figure 10a. LTC4278 Switching Regulator Feedback Amplifier



Figure 10b. LTC4278 Switching Regulator Timing Diagram



to transformer leakage inductance. The latter causes a voltage spike on the primary side, not directly related to output voltage. Some time is also required for internal settling of the feedback amplifier circuitry. In order to maintain immunity to these phenomena, a fixed delay is introduced between the switch turn-off command and the enabling of the feedback amplifier. This is termed "enable delay." In certain cases where the leakage spike is not sufficiently settled by the end of the enable delay period, regulation error may result. See the subsequent sections for further details.

#### Collapse Detect

Once the feedback amplifier is enabled, some mechanism is then required to disable it. This is accomplished by a collapse detect comparator, which compares the flyback voltage (FB) to a fixed reference, nominally 80% of  $V_{FB}$ . When the flyback waveform drops below this level, the feedback amplifier is disabled.

#### Minimum Enable Time

The feedback amplifier, once enabled, stays on for a fixed minimum time period, termed "minimum enable time." This prevents lockup, especially when the output voltage is abnormally low, e.g., during start-up. The minimum enable time period ensures that the  $V_{CMP}$  node is able to "pump up" and increase the current mode trip point to the level where the collapse detect system exhibits proper operation. This time is set internally.

#### Effects of Variable Enable Period

The feedback amplifier is enabled during only a portion of the cycle time. This can vary from the fixed minimum enable time described to a maximum of roughly the off switch time minus the enable delay time. Certain parameters of feedback amp behavior are directly affected by the variable enable period. These include effective transconductance and  $V_{CMP}$  node slew rate.

#### Load Compensation Theory

The LTC4278 uses the flyback pulse to obtain information about the isolated output voltage. An error source is caused by transformer secondary current flow through the synchronous MOSFET  $R_{DS(ON)}$  and real life nonzero impedances of the transformer secondary and output capacitor. This was represented previously by the expression,  $I_{SEC} \bullet (ESR + R_{DS(ON)})$ . However, it is generally more useful to convert this expression to effective output impedance. Because the secondary current only flows during the off portion of the duty cycle (DC), the effective output impedance equals the lumped secondary impedance divided by off time DC.

Since the off-time duty cycle is equal to 1 - DC, then:

$$R_{S(OUT)} = \frac{ESR + R_{DS(ON)}}{1 - DC}$$

where:

 $R_{S(OUT)}$  = effective supply output impedance

DC = duty cycle

R<sub>DS(ON)</sub> and ESR are as defined previously

This impedance error may be judged acceptable in less critical applications, or if the output load current remains relatively constant. In these cases, the external FB resistive divider is adjusted to compensate for nominal expected error. In more demanding applications, output impedance error is minimized by the use of the load compensation function. Figure 11 shows the block diagram of the load compensation function. Switch current is converted to a voltage by the external sense resistor, averaged and lowpass filtered by the internal 50k resistor R<sub>CMPF</sub> and the external capacitor on C<sub>CMP</sub>. This voltage is impressed across the external R<sub>CMP</sub> resistor by op amp A1 and transistor Q3 producing a current at the collector of Q3 that is subtracted from the FB node. This effectively increases the voltage required at the top of the R1/R2 feedback divider to achieve equilibrium.

The average primary-side switch current increases to maintain output voltage regulation as output loading increases. The increase in average current increases  $R_{CMP}$  resistor current which affects a corresponding increase in sensed output voltage, compensating for the IR drops.



Assuming relatively fixed power supply efficiency, Eff, power balance gives:

 $P_{OUT} = Eff \bullet P_{IN}$ 

 $V_{OUT} \bullet I_{OUT} = Eff \bullet V_{IN} \bullet I_{IN}$ 

Average primary-side current is expressed in terms of output current as follows:

 $I_{IN} = K1 \bullet I_{OUT}$ 

where:

K1=
$$\frac{V_{OUT}}{V_{IN} \bullet Eff}$$

So, the effective change in  $V_{OUT}$  target is:

$$\Delta V_{OUT} = K1 \bullet \frac{R_{SENSE}}{R_{CMP}} \bullet R1 \bullet N_{SF} \bullet \Delta I_{OUT}$$

thus:

$$\frac{\Delta V_{OUT}}{\Delta I_{OUT}} = K1 \bullet \frac{R_{SENSE}}{R_{CMP}} \bullet R1 \bullet N_{SF}$$

where:

K1 = dimensionless variable related to  $V_{IN}, \, V_{OUT}$  and efficiency, as previously explained

R<sub>SENSE</sub> = external sense resistor



Figure 11. Load Compensation Diagram

Nominal output impedance cancellation is obtained by equating this expression with  $R_{S(OUT)}$ :

$$K1 \bullet \frac{R_{SENSE}}{R_{CMP}} \bullet R1 \bullet N_{SF} = \frac{ESR + R_{DS(ON)}}{1 - DC}$$

Solving for R<sub>CMP</sub> gives:

$$R_{CMP} = K1 \bullet \frac{R_{SENSE} \bullet (1 - DC)}{ESR + R_{DS(ON)}} \bullet R1 \bullet N_{SF}$$

The practical aspects of applying this equation to determine an appropriate value for the  $R_{CMP}$  resistor are discussed subsequently in the Applications Information section.

#### **Transformer Design**

Transformer design/specification is the most critical part of a successful application of the LTC4278. The following sections provide basic information about designing the transformer and potential tradeoffs. If you need help, the LTC Applications group is available to assist in the choice and/or design of the transformer.

#### **Turns Ratios**

The design of the transformer starts with determining duty cycle (DC). DC impacts the current and voltage stress on the power switches, input and output capacitor RMS currents and transformer utilization (size vs power). The ideal turns ratio is:

$$N_{IDEAL} = \frac{V_{OUT}}{V_{IN}} \bullet \frac{1 - DC}{DC}$$

Avoid extreme duty cycles, as they generally increase current stresses. A reasonable target for duty cycle is 50% at nominal input voltage.

For instance, if we wanted a 48V to 5V converter at 50% DC then:

$$N_{\text{IDEAL}} = \frac{5}{48} \bullet \frac{1 - 0.5}{0.5} = \frac{1}{9.6}$$

In general, better performance is obtained with a lower turns ratio. A DC of 45.5% yields a 1:8 ratio.

